Surface Mount Schottky Power Rectifier

SMA Power Surface Mount Package

This device employs the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

Features

- Compact Package with J–Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop
- AEC-Q101 Qualified and PPAP Capable
- NRVBA Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- All Packages are Pb-Free*

Mechanical Characteristics:

- Case: Molded Epoxy
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode Lead Indicated by Either Notch in Plastic Body or Polarity Band
- Device Meets MSL1 Requirements
- ESD Ratings:
 - ◆ Machine Model = C (> 400 V)
 - ♦ Human Body Model = 3B (> 8000 V)



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SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES, 30 VOLTS



SMA CASE 403D PLASTIC

MARKING DIAGRAM



B1L3 = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week

ORDERING INFORMATION

= Pb-Free Package

Device	Package	Shipping [†]		
MBRA130LT3G	SMA (Pb-Free)	5,000 / Tape & Reel **		
NRVBA130LT3G	SMA (Pb-Free)	5,000 / Tape & Reel **		

^{** 12} mm Tape, 13" Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V	
Average Rectified Forward Current (At Rated V_R , $T_C = 105$ °C)	Io	1.0	А	
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 100 kHz, $T_C = 105$ °C)	I _{FRM}	2.0	А	
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	25	A	
Storage Temperature	T _{stg}	-55 to +150	°C	
Operating Junction Temperature	TJ	-55 to +125	°C	
Voltage Rate of Change, (Rated V _R , T _J = 25°C)	dv/dt	10,000	V/μs	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

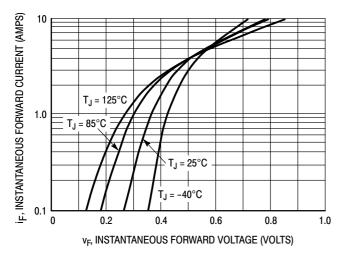
Characteristic	Symbol	Value	Unit	
Thermal Resistance — Junction-to-Lead (Note 1) Thermal Resistance — Junction-to-Ambient (Note 1)	$R_{ hetaJL} \ R_{ hetaJA}$	35 86	°C/W	

^{1.} Mounted on 2" Square PC Board with 1" Square Total Pad Size, PC Board FR4.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Val	Unit	
Maximum Instantaneous Forward Voltage (Note 2)	V _F	T _J = 25°C	T _J = 100°C	Volts
(I _F = 1.0 A) see Figure 2 (I _F = 2.0 A)		0.41 0.47	0.35 0.43	
Maximum Instantaneous Reverse Current	I _R	T _J = 25°C	T _J = 100°C	mA
(V _R = 30 V) see Figure 4 (V _R = 15 V)		1.0 0.4	25 12	

^{2.} Pulse Test: Pulse Width \leq 250 $\mu s,$ Duty Cycle \leq 2.0%.



1.0

T_J = 125°C

T_J = 85°C

T_J = 25°C

V_F MAXIMUM INSTANTANEOUS FORWARD VOLTAGE (VOLTS)

Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

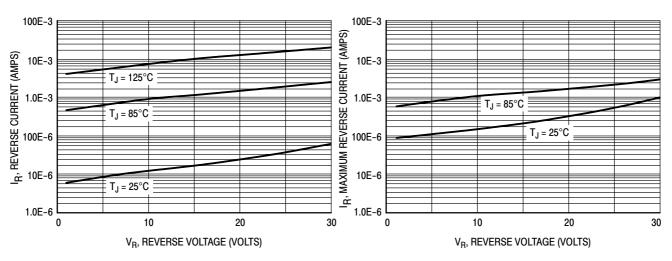
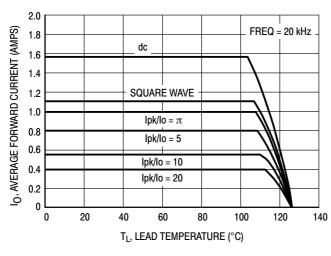


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current



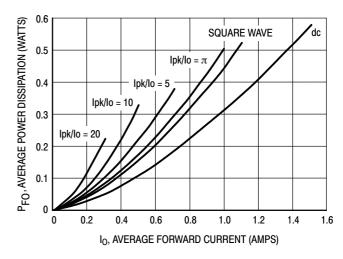


Figure 5. Current Derating

Figure 6. Forward Power Dissipation

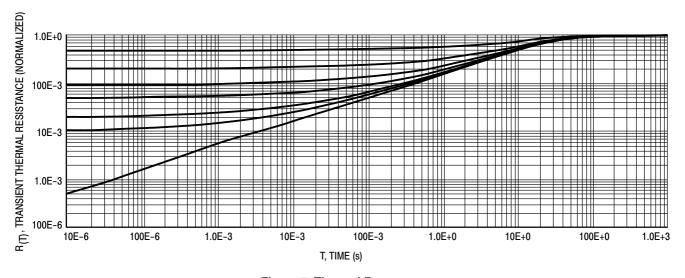


Figure 7. Thermal Response

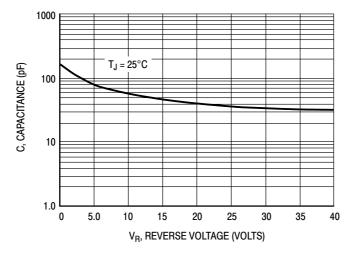
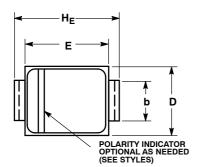


Figure 8. Capacitance

PACKAGE DIMENSIONS

SMA

CASE 403D-02 **ISSUE F**



NOTES:

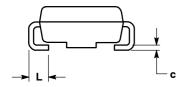
- 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14 5M 1982
- 2. CONTROLLING DIMENSION: INCH.

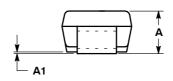
	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.97	2.10	2.20	0.078	0.083	0.087	
A1	0.05	0.10	0.15	0.002	0.004	0.006	
b	1.27	1.45	1.63	0.050	0.057	0.064	
С	0.15	0.28	0.41	0.006	0.011	0.016	
D	2.29	2.60	2.92	0.090	0.103	0.115	
E	4.06	4.32	4.57	0.160	0.170	0.180	
HE	4.83	5.21	5.59	0.190	0.205	0.220	
L	0.76	1.14	1.52	0.030	0.045	0.060	



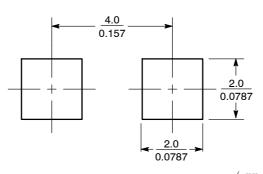
STYLE 1: PIN 1. CATHODE (POLARITY BAND)

2. ANODE





SOLDERING FOOTPRINT*



mm SCALE 8:1

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^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com